

# Characterization of Single-Electron Events Using a Skipper-CCD

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#### Characterization of SEEs with a SCCD

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#### SENSEI: Characterization of Single-Electron Events Using a Skipper Charge-Coupled Device

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# Electron recoils for sub-GeV DM in Skipper-CCDs

- \* Benchmark models:
  - DM-e<sup>-</sup> scattering, DM absorption
- Silicon Skipper-CCDs as ionization detectors

DM-e<sup>-</sup> interaction (or absorption)

Energy transfer via **electron recoil** 

Ionized h<sup>+</sup> are **captured** by potential well

Signal is readout **after** exposure is finished.

DM range mass: 1-1000 MeV
 (~eV on DM absorption)



# **CCD** basics

- CCD = pixelated silicon array
- ~2g per device of high-resistivity fully-depleted silicon
- Output stage Prescan >99.9% charge collection and transfer efficiency ۲ H3 H2 H1 H3 H2 H1 H3 H2 H1 H3 H2 H1 SW Serial register ~**5.5Mpixels** of 15x15x675 µm<sup>3</sup> each . . . . ۲ Transfer gate TG-V3-(a)polysilicon V2gate electrodes V1-3 phase Active Area V3pixel ~18 kΩ· cm structure V2-V1sensitive V3volume 675µm V2-V1-V3-V2bias buried *p* channel voltage V1n--n--n---

# **Skipper-CCD** basics

- \* DM range mass: 1-1000 MeV (~eV on DM absorption)
  - Very small **signals** 
    - Very low energy threshold

 Skipper technology allows to read repeatedly the same pixel to achieve sub-electron noise



• Low energy threshold down to 1.2eV (Si band gap)

# **MINOS setup: location and shielding**

 Setup ~107m below surface at shallow underground MINOS site @FNAL to reduce environmental background radiation.



 Inner (1" each) and outer (2" each) lead bricks reduces environmental gamma radiation

• Operated at **135K** and high-vacuum regime to reduce dark current without generating CTI





# Data-taking cycle

- > Data-taking cycle was divided into 3 phases: **Cleaning**, **Exposure** and **Readout**.
  - Cleaning: voltages are changed so surface traps energy levels or interface states are filled ("reset").
     This way they do not contribute to DC. CCD is readout in order to erase charges this "reset" leaves.
  - Exposure: voltages keep fixed. Note bias voltage in output transistor is set to 0V so no amplifier light is emitted.
  - **Readout**: signal is collected.



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#### **Basic model**

- > Data-taking cycle was divided into 3 phases: Cleaning, Exposure and Readout.
- ➤ We will define three type of events based on these three phases:
  - $\mu_{EXP}$ : rate of SEEs produced during Exposure
  - $\mu_{RO}$ : rate of SEEs produced during Readout
  - μ<sub>sc</sub>: rate of SEEs produced by the change in the voltages as charge gets transferred ("clocking") during both Readout and Cleaning but does not scale with time (exposure-independent events).

$$\mu_{(t_{EXP},t_{RO})} = \mu_{(t_{EXP})} + \mu_{(t_{RO})} + \mu_{SC}$$

$$\mu_{(t_{EXP},t_{RO})} = \lambda_{EXP} \, t_{EXP} + \lambda_{RO} \, t_{RO} + \mu_{SC}$$

### **SEE** contributions

- We will differentiate three types of SEE events
  - Dark current. SEEs that are uniformly generated across the CCD and that scale linearly with time. They are produced during both Exposure and Readout.

Amplifier light. SEEs generated from the interaction of amplifier light with the pixels of the CCD. They
are localized near the amplifier and scale linearly with time. They are produced during Readout.

 Spurious charge. SEEs generated due to clocking of pixels. They are produced during Readout but do not scale with time. They are spread uniformly across the CCD.

# All in all

$egin{array}{c} {f Contribution} \ (e^-/{ m pix}) \end{array}$		נ	Cractic 1		
		Linear		Independent	Spatial
		Exposure	Readout	maependent	distribution
Dark	Intrinsic	)t	$rac{\lambda_{ m DC}}{2} t_{ m RO}$	-	Uniform
current	Extrinsic	VDC VEXP			Uniform
Amplifier-light current		-	$\lambda_{ m AL} \; t_{ m RO}$	-	Localized
Spurious charge		-	-	$\mu_{ m SC}$	Uniform

$$\mu_{(t_{EXP},t_{RO})} = \lambda_{DC} \ t_{EXP} + (rac{\lambda_{DC}}{2} + \lambda_{AL}) \ t_{RO} + \mu_{SC}$$

 $\rightarrow$  Even though sub-electron readout noise allowed us to take a closer look into SEEs and DC, we've found in 2020 that our DC rate is way higher than the theoretical one at 135K:



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$$1.6 imes 10^{-4}e-/pix/day>>\sim 1 imes 10^{-6}e-/pix/day$$

 $\rightarrow$  Origin? Essig et al. (2011.13939) proposed the source of this discrepancy may come from the interaction of high energy events with the CCD as it is was hinted in SENSEI 2020:



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 $\rightarrow$  Because of this, we suggested introducing the concept of **extrinsic** DC as SEE that appear to be usual DC (uniform in space, linear in time) but seem to come from an **interaction between the environment and the CCD**.

 $\rightarrow$  We will refer to SEE that come from thermal agitation as **intrinsic** DC.

 $\rightarrow$  Hints were found, still unable to make direct measurement or test a model.

 $\rightarrow$  This work does not report a value for both extrinsic and intrinsic DC, without discriminating between them.

#### Dark current: λ<sub>D</sub>c

 $\rightarrow$  **Determination of**  $\lambda_{\text{DC}}$ . Fix READOUT time, change EXPOSURE time.



# **Amplifier light**

 $\rightarrow$  Increase linearly with time but spatially localized near the readout stage.

 $\rightarrow$  In SENSEI 2019 this effect was a huge SEE contributor





FIG. 2. Schematic illustration of a Skipper-CCD readout stage. H1, H2 and H3 are the last horizontal clocks in the serial register before the Summing Well (SW).

# Amplifier light study

→ How does M1 output transistor bias voltage affect light emission and readout noise?



FIG. 5. SEEs per pixel (left axis) and single-sample readout noise (red, right axis) as a function of the drain voltage of the M1 transistor ( $V_{DD}$ ). In black, we show the SEEs per pixel collected for each voltage ( $\mu_{(t_{ro})}$ ) and in blue the AL contribution ( $\mu_{AL}$ ), estimated from Eq. (6). The black dashed line shows the estimation for  $\mu_{SC}$ . Images are taken from dataset *B*.

V <sub>DD</sub>	$\lambda_{ m AL}~(10^{-4}~e^-/{ m pix}/{ m day})$
-21	$(0.36 \pm 0.18)$
-22	$(19.91 \pm 1.26)$

#### Spurious charge

- $\rightarrow$  SEE generated from **clocking** of pixels.
- $\rightarrow$  Depends mostly on **voltage swings** and **clock shaping**. Increases with lower temperatures.
- $\rightarrow$  Low energy background to possible DM signal (reduction and characterization)
- $\rightarrow$  In SENSEI2020,



### Transfer curves: λ<sub>AL</sub> and μsc

 $\rightarrow$  Determination of  $\lambda_{AL}$  and  $\mu_{SC}$ . Change READOUT time, set EXPOSURE time to 0.

$$\mu(t_{\rm RO}) = \left(\frac{\lambda_{\rm DC}}{2} + \lambda_{\rm AL}\right) t_{\rm RO} + \mu_{\rm SC}$$



V <sub>DD</sub>	$\mu_{\rm SC}  (10^{-4}  e^-/{\rm pix})$
-21	$(1.52 \pm 0.07)$
-22	$(1.59\pm0.12)$

# All contributions: results

V <sub>DD</sub>	External Shield	$\lambda_{ m DC}$	$\lambda_{ m AL}$	$\mu_{ m SC}$
-21	Yes	$(1.59 \pm 0.16)$	$(0.36 \pm 0.18)$	$(1.52 \pm 0.07)$
		$10^{-4} e^-/\mathrm{pix/day}$	$10^{-4} e^-/\mathrm{pix}/\mathrm{day}$	$10^{-4} e^{-}/{\rm pix}$

 $\rightarrow$  Considering  $\lambda_{AL}$  negligible, in a 24 hours exposure image (typical science run) we would have the same amount of SEE coming from DC than from SC.

 $\rightarrow$  SC can be further reduced by **pixel binning** and **swing shaping**.

 $\rightarrow$  This limiting factor in DC may come from both **extrinsic** and **intrinsic** contributions.

 $\rightarrow$  Origin of remaining DC is being investigated at the moment.

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# **THANKS!**